

LM124-LM224-LM324

Low power quad operational amplifiers

Features

■ Wide gain bandwidth: 1.3 MHz

■ Input common-mode voltage range includes ground

■ Large voltage gain: 100 dB

■ Very low supply current per amplifier: 375 µA

■ Low input bias current: 20 nA

 Low input offset voltage: 5 mV max. (For more accurate applications, use the equivalent parts LM124A-LM224A-LM324A which feature 3 mV max.)

■ Low input offset current: 2 nA

■ Wide power supply range:

Single supply: +3 V to +30 VDual supplies: ±1.5 V to ±15 V

Description

These circuits consist of four independent, high gain, internally frequency compensated operational amplifiers. They operate from a single power supply over a wide range of voltages. Operation from split power supplies is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage.



N DIP14 (Plastic package)



SO-14
(Plastic micropackage)



TSSOP-14 (Thin shrink small outline package)

Order codes

Part number	Temperature range	Package	Packing
LM124N	-55°C, +125°C		Tube
LM124D/DT	-55 0, +125 0	SO	Tube or tape & reel
LM224N		DIP	Tube
LM224D/DT	-40°C, +105°C	SO	Tube or tape & reel
LM224PT		TSSOP (Thin shrink outline package)	Tape & reel
LM324N		DIP	Tube
LM324D/DT	0°C, +70°C	SO	Tube or tape & reel
LM324PT	3 3, 170 3	TSSOP (Thin shrink outline package)	Tape & reel

Contents LM124-LM224-LM324

Contents

1	Pin & schematic diagram
2	Absolute maximum ratings
3	Electrical characteristics
4	Typical single-supply applications10
5	Macromodels
6	Package information
	6.1 DIP14 package
	6.2 SO-14 package
	6.3 TSSOP14 package
7	Revision history

1 Pin & schematic diagram

Figure 1. Pin connections (top view)

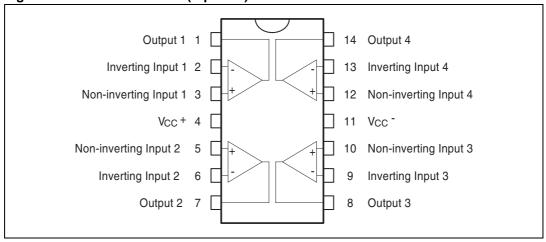
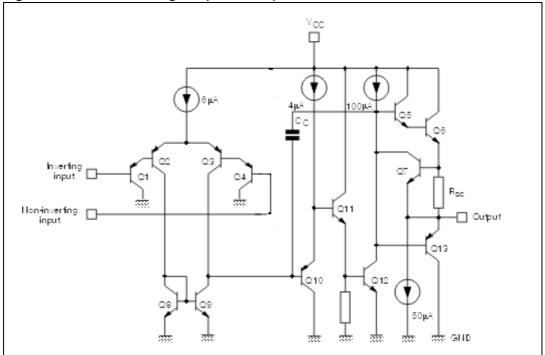


Figure 2. Schematic diagram (1/4 LM124)



2 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	LM124	LM224	LM324	Unit
V _{CC}	Supply voltage		±16 or 32		V
V _i	Input voltage		32		V
V _{id}	Differential input voltage (1)		32		V
P _{tot}	Power dissipation N suffix D suffix	500	500 400	500 400	mW
	Output short-circuit duration (2)		Infinite		
I _{in}	Input current (3)	50	50	50	mA
T _{oper}	Operating free-air temperature range	-55 to +125	-40 to +105	0 to +70	°C
T _{stg}	Storage temperature range	-	65 to +150		°C
Tj	Maximum junction temperature		150		°C
R _{thja}	Thermal resistance junction to ambient ⁽⁴⁾ SO14 TSSOP14 DIP14		103 100 83		°C/W
R _{thjc}	Thermal resistance junction to case SO14 TSSOP14 DIP14	31 32 33			°C/W
	HBM: human body model ⁽⁵⁾		250		
ESD	MM: machine model ⁽⁶⁾	150			V
	CDM: charged device model		1500		

- 1. Either or both input voltages must not exceed the magnitude of V_{CC}^+ or V_{CC}^- .
- 2. Short-circuits from the output to V_{CC} can cause excessive heating if $V_{CC} > 15V$. The maximum output current is approximately 40 mA independent of the magnitude of V_{CC} . Destructive dissipation can result from simultaneous short-circuits on all amplifiers.
- 3. This input current only exists when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistor becoming forward biased and thereby acting as input diode clamps. In addition to this diode action, there is also NPN parasitic action on the IC chip. This transistor action can cause the output voltages of the op-amps to go to the V_{CC} voltage level (or to ground for a large overdrive) for the time during which an input is driven negative.
 This is not destructive and normal output is restored for input voltages above -0.3 V.
- Short-circuits can cause excessive heating. Destructive dissipation can result from simultaneous shortcircuits on all amplifiers. These are typical values given for a single layer board (except for TSSOP, a twolayer board).
- 5. Human body model, 100 pF discharged through a 1.5 k Ω resistor into pin of device.
- 6. Machine model ESD, a 200 pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor $< 5 \Omega$), into pin-to-pin of device.

3 Electrical characteristics

Table 2. V_{CC}^+ = +5 V, V_{CC}^- = Ground, V_o = 1.4 V, T_{amb} = +25° C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{io}	Input offset voltage ⁽¹⁾ $T_{amb} = +25^{\circ} C$ $LM124-LM224$ $LM324$		2	5 7	mV
	$T_{min} \le T_{amb} \le T_{max}$ $LM124-LM224$ $LM324$			7 9	
l _{io}	Input offset current $T_{amb} = +25^{\circ} C$ $T_{min} \le T_{amb} \le T_{max}$		2	30 100	nA
I _{ib}	Input bias current $^{(2)}$ $T_{amb} = +25^{\circ} C$ $T_{min} \le T_{amb} \le T_{max}$		20	150 300	nA
A _{vd}	Large signal voltage gain V_{CC}^+ = +15 V, R_L = 2 k Ω , V_o = 1.4 V to 11.4 V T_{amb} = +25° C $T_{min} \le T_{amb} \le T_{max}$	50 25	100		V/mV
SVR	Supply voltage rejection ratio ($R_s \le 10 \text{ k}\Omega$) $V_{CC}^+ = 5 \text{ V to } 30 \text{ V}$ $T_{amb} = +25^{\circ} \text{ C}$ $T_{min} \le T_{amb} \le T_{max}$	65 65	110		dB
I _{CC}	Supply current, all Amp, no load $T_{amb} = +25^{\circ} \text{ C}$ $V_{CC} = +5 \text{ V}$ $V_{CC} = +30 \text{ V}$		0.7 1.5	1.2 3	mA
	$T_{min} \le T_{amb} \le T_{max}$ $V_{CC} = +5 \text{ V}$ $V_{CC} = +30 \text{ V}$		0.8 1.5	1.2 3	
V _{icm}	Input common mode voltage range $V_{CC} = +30 \text{ V}^{(3)}$ $T_{amb} = +25^{\circ} \text{ C}$ $T_{min} \leq T_{amb} \leq T_{max}$	0 0		V _{CC} -1.5 V _{CC} -2	٧
CMR	Common mode rejection ratio ($R_s \le 10 \text{ k}\Omega$) $T_{amb} = +25^{\circ} \text{ C}$ $T_{min} \le T_{amb} \le T_{max}$	70 60	80		dB
I _{source}	Output current source ($V_{id} = +1 \text{ V}$) $V_{CC} = +15 \text{ V}, V_{o} = +2 \text{ V}$	20	40	70	mA

577

Electrical characteristics LM124-LM224-LM324

Table 2. V_{CC}^+ = +5 V, V_{CC}^- = Ground, V_o = 1.4 V, T_{amb} = +25° C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{sink}	Output sink current ($V_{id} = -1 \text{ V}$) $V_{CC} = +15 \text{ V}, V_o = +2 \text{ V}$ $V_{CC} = +15 \text{ V}, V_o = +0.2 \text{ V}$	10 12	20 50		mΑ μΑ
V _{OH}	High level output voltage $V_{CC} = +30 \text{ V}$ $T_{amb} = +25^{\circ} \text{ C, } R_{L} = 2 \text{ k}\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$ $T_{amb} = +25^{\circ} \text{ C, } R_{L} = 10 \text{ k}\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$	26 26 27 27	27 28		V
	V_{CC} = +5 V, R_L = 2 k Ω T_{amb} = +25°C $T_{min} \le T_{amb} \le T_{max}$	3.5			
V _{OL}	Low level output voltage (R _L = 10 k Ω) T_{amb} = +25°C $T_{min} \le T_{amb} \le T_{max}$		5	20 20	mV
SR	Slew rate V_{CC} = 15 V, V_i = 0.5 to 3 V, R_L = 2 k Ω , C_L = 100 pF, unity gain		0.4		V/µs
GBP	Gain bandwidth product V_{CC} = 30 V, f = 100 kHz, V_{in} = 10 mV, R_L = 2 k Ω , C_L = 100 pF		1.3		MHz
THD	Total harmonic distortion $f = 1 \text{ kHz}, A_V = 20 \text{ dB}, R_L = 2 \text{ k}\Omega, V_O = 2 \text{ V}_{pp}, C_L = 100 \text{ pF}, V_{CC} = 30 \text{ V}$		0.015		%
e _n	Equivalent input noise voltage $f = 1 \text{ kHz}, R_s = 100 \Omega, V_{CC} = 30 \text{ V}$		40		$\frac{\text{nV}}{\sqrt{\text{Hz}}}$
DV _{io}	Input offset voltage drift		7	30	μV/°C
DI _{io}	Input offset current drift		10	200	pA/°C
V ₀₁ /V ₀₂	Channel separation $^{(4)}$ 1 kHz \leq f \leq 20 kHZ		120		dB

^{1.} $V_0 = 1.4 \text{ V}, R_S = 0 \Omega, 5 \text{ V} < {V_{CC}}^+ < 30 \text{ V}, 0 < {V_{ic}} < {V_{CC}}^+ - 1.5 \text{ V}$

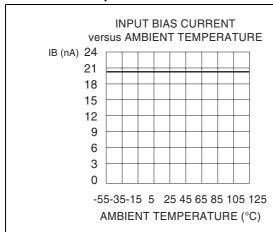
^{2.} The direction of the input current is out of the IC. This current is essentially constant, independent of the state of the output so there is no change in the load on the input lines.

^{3.} The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0. V. The upper end of the common-mode voltage range is V_{CC}^+ - 1.5 V, but either or both inputs can go to +32 V without damage.

^{4.} Due to the proximity of external components, ensure that stray capacitance between these external parts does not cause coupling. Typically, this can be detected because this type of capacitance increases at higher frequencies.

Figure 3. Input bias current vs. ambient temperature

Figure 4. Current limiting



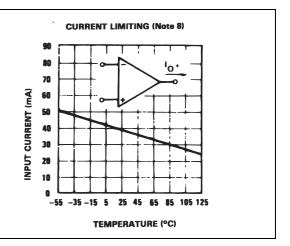
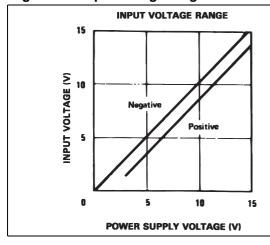


Figure 5. Input voltage range

Figure 6. Supply current



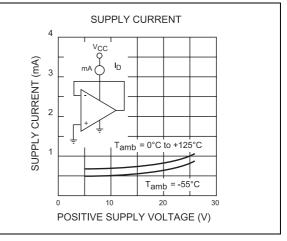
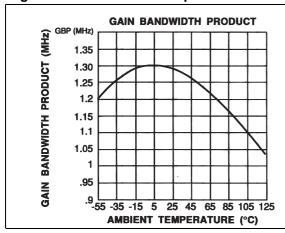
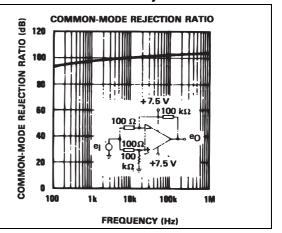


Figure 7. Gain bandwidth product

Figure 8. Common mode rejection ratio





Electrical characteristics LM124-LM224-LM324

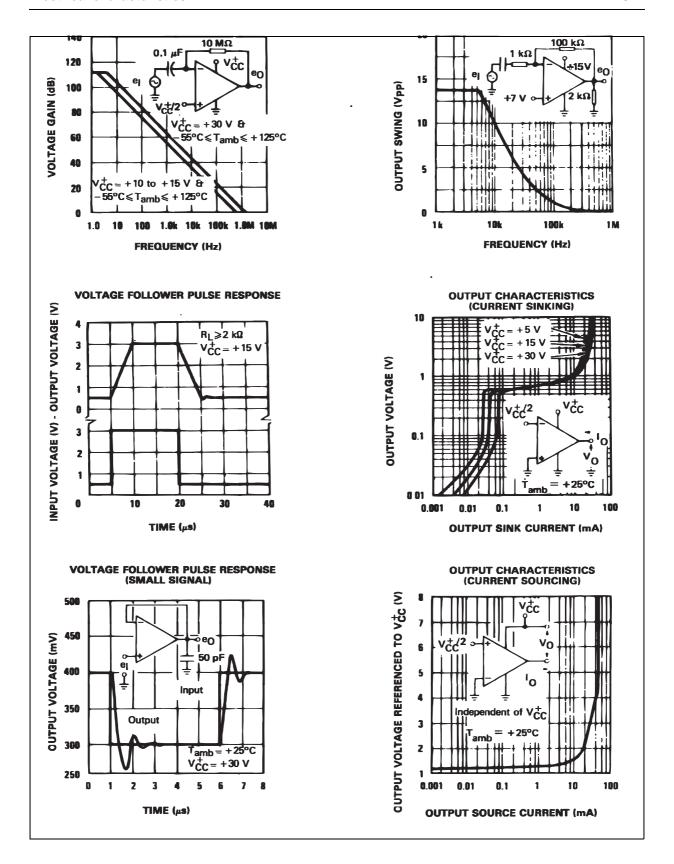


Figure 9. Input current

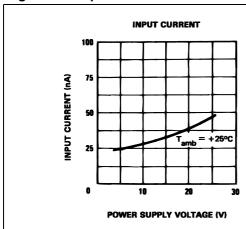


Figure 10. Large signal voltage gain

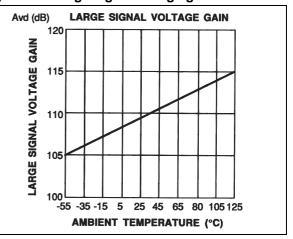
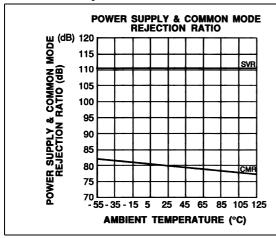
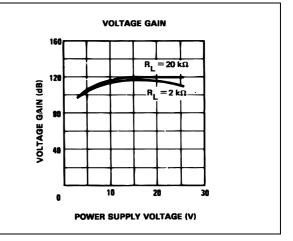


Figure 11. Power supply & common mode rejection ratio

Figure 12. Voltage gain





Typical single-supply applications 4

Figure 13. AC coupled inverting amplifier

Figure 14. High input Z adjustable gain DC instrumentation amplifier

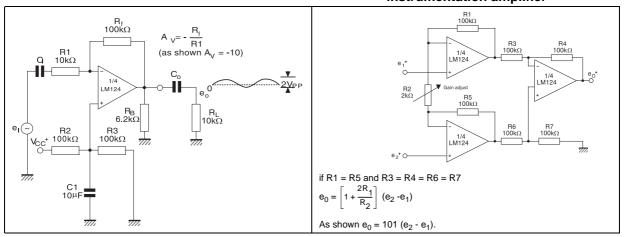


Figure 15. AC coupled non inverting amplifier Figure 16. DC summing amplifier

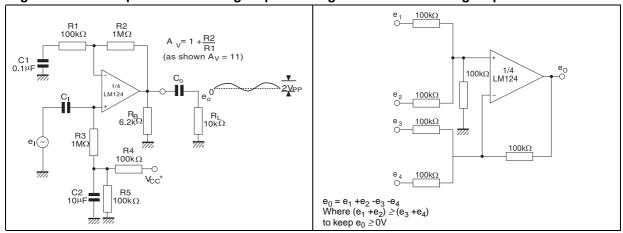


Figure 17. Non-inverting DC gain

Figure 18. Low drift peak detector $A_V = 1 + \frac{R2}{R1}$ (As shown A_V = 101) $10k\Omega$ e_o 1/4 LM124 +5V **0.**001μF R2 1ΜΩ \mathbb{S} R1 10kΩ Input current compensation 1111 Polycarbonate or polyethylene e_I (mV)

Figure 19. Active bandpass filter

Figure 20. High input Z, DC differential amplifier

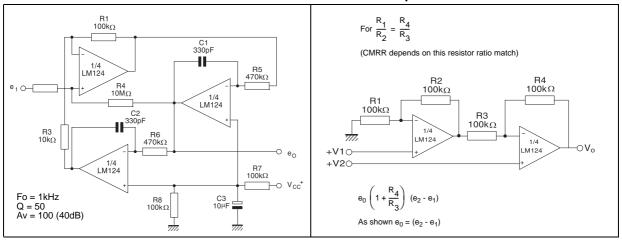
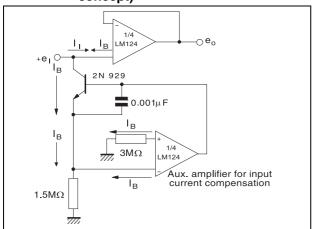


Figure 21. Using symmetrical amplifiers to reduce input current (general concept)



Macromodels LM124-LM224-LM324

5 Macromodels

Note: Please consider the following before using this macromodel:

All models are a trade-off between accuracy and complexity (i.e. simulation time).

Macromodels are not a substitute to breadboarding; rather, they confirm the validity of a design approach and help to select surrounding component values.

A macromodel emulates the **nominal** performance of a **typical** device within **specified operating conditions** (temperature, supply voltage, etc.). Thus the macromodel is often not as exhaustive as the datasheet, its purpose is to illustrate the main parameters of the product.

Data derived from macromodels that is used outside of the specified conditions (V_{cc} , temperature, etc.) or even worse, outside of the device operating conditions (V_{cc} , V_{icm} , etc.) is not reliable in any way.

```
** Standard Linear Ics Macromodels, 1993.
** CONNECTIONS :
* 1 INVERTING INPUT
* 2 NON-INVERTING INPUT
* 3 OUTPUT
* 4 POSITIVE POWER SUPPLY
* 5 NEGATIVE POWER SUPPLY
.SUBCKT LM124 1 3 2 4 5
******
                     *************
.MODEL MDTH D IS=1E-8 KF=3.104131E-15 CJO=10F
* INPUT STAGE
CIP 2 5 1.000000E-12
CIN 1 5 1.00000E-12
EIP 10 5 2 5 1
EIN 16 5 1 5 1
RIP 10 11 2.600000E+01
RIN 15 16 2.600000E+01
RIS 11 15 2.003862E+02
DIP 11 12 MDTH 400E-12
DIN 15 14 MDTH 400E-12
VOFP 12 13 DC 0
VOFN 13 14 DC 0
IPOL 13 5 1.000000E-05
CPS 11 15 3.783376E-09
DINN 17 13 MDTH 400E-12
VIN 17 5 0.000000e+00
DINR 15 18 MDTH 400E-12
VIP 4 18 2.000000E+00
FCP 4 5 VOFP 3.400000E+01
FCN 5 4 VOFN 3.400000E+01
FIBP 2 5 VOFN 2.000000E-03
FIBN 5 1 VOFP 2.000000E-03
* AMPLIFYING STAGE
FIP 5 19 VOFP 3.600000E+02
FIN 5 19 VOFN 3.600000E+02
```

12/19

LM124-LM224-LM324 Macromodels

```
RG1 19 5 3.652997E+06
RG2 19 4 3.652997E+06
CC 19 5 6.000000E-09
DOPM 19 22 MDTH 400E-12
DONM 21 19 MDTH 400E-12
HOPM 22 28 VOUT 7.500000E+03
VIPM 28 4 1.500000E+02
HONM 21 27 VOUT 7.500000E+03
VINM 5 27 1.500000E+02
EOUT 26 23 19 5 1
VOUT 23 5 0
ROUT 26 3 20
COUT 3 5 1.000000E-12
DOP 19 25 MDTH 400E-12
VOP 4 25 2.242230E+00
DON 24 19 MDTH 400E-12
VON 24 5 7.922301E-01
.ENDS
```

The values provided in *Table 3* are derived from this macromodel.

Table 3. $V_{cc}^+ = +15V$, $V_{cc}^- = 0V$, $T_{amb} = 25$ °C (unless otherwise specified)

Symbol	Conditions	Value	Unit
V_{io}		0	mV
A _{vd}	$R_L = 2 k\Omega$	100	V/mV
I _{cc}	No load, per amplifier	350	μA
V _{icm}		-15 to +13.5	V
V _{OH}	$R_{L} = 2 k\Omega (V_{CC}^{+}=15V)$	+13.5	V
V _{OL}	$R_L = 10 \text{ k}\Omega$	5	mV
I _{os}	$V_0 = +2 \text{ V}, V_{CC} = +15 \text{ V}$	+40	mA
GBP	$R_L = 2 \text{ k}\Omega$, $C_L = 100 \text{ pF}$	1.3	MHz
SR	$R_L = 2 \text{ k}\Omega$, $C_L = 100 \text{ pF}$	0.4	V/µs

577

Package information LM124-LM224-LM324

6 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

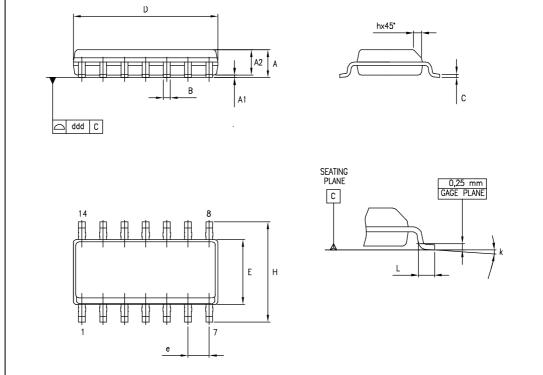
6.1 DIP14 package

			Dimer	nsions		
Ref.		Millimeters				
	Min.	Тур.	Max.	Min.	Тур.	Max.
a1	0.51			0.020		
В	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100
Z B E E						
D						

15/19

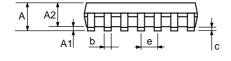
6.2 SO-14 package

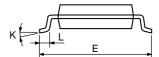
	Dimensions						
Ref.		Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.75			0.068	
A1	0.1		0.2	0.003		0.007	
A2			1.65			0.064	
В	0.35		0.46	0.013		0.018	
С	0.19		0.25	0.007		0.010	
c1			45°	(typ.)			
D	8.55		8.75	0.336		0.344	
Н	5.8		6.2	0.228		0.244	
е		1.27			0.050		
Е	3.8		4.0	0.149		0.157	
L	0.5		0.127	0.019		0.050	
k	8° (max.)						

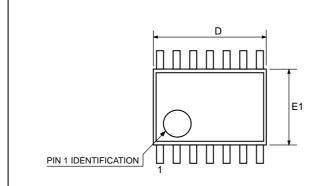


6.3 TSSOP14 package

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.2			0.047	
A1	0.05	0.010	0.15	0.002	0.004	0.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
С	0.09		0.20	0.004		0.0089	
D	4.9	5	5.1	0.193	0.197	0.201	
Е	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.169	0.173	0.176	
е		0.65 BSC			0.0256 BSC		
K	0°		8°	0°		8°	
L1	0.45	0.60	0.75	0.018	0.024	0.030	







5/

Revision history LM124-LM224-LM324

7 Revision history

Date	Revision	Changes
1-Oct2003	1	First release.
2-Jan-2005	2	Modifications on AMR <i>Table 1 on page 4</i> (explanation of V_{id} and V_{i} limits).
1-Jun-2005	3	ESD protection inserted in Table 1 on page 4.
2-Jan-2006	4	T _j and R _{thjc} parameters added in <i>Table 1. on page 4</i> .
4-Oct-2006	5	Editorial update. <i>Table 3</i> moved to <i>Section 5: Macromodels on page 12.</i>

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

577